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SD3931-10

RF power transistors HF/VHF/UHF N-channel MOSFETs

Features

- Excellent thermal stability
- Common source configuration
- P_{OUT} = 175 W min. with 23 dB gain @ 150 MHz
- In compliance with the 2002/95/EC European directive

Description

The SD3931-10 is an N-channel MOS field-effect RF power transistor. It is intended for use in 100 V DC large signal applications up to 150 MHz.

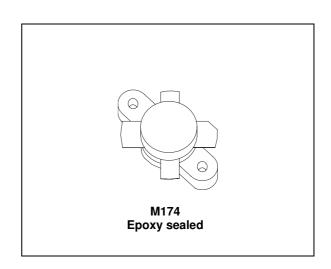


Figure 1. Pin connection

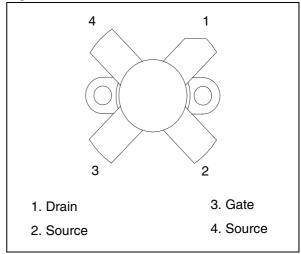


Table 1. Device summary

Order code	Marking	Package	Packaging	
SD3931-10	SD3931-10	M174	Plastic tray	

September 2010 Doc ID 13657 Rev 5 1/13

Contents SD3931-10

Contents

1	Elect	rical data	3
	1.1	Maximum ratings	3
	1.2	Thermal data	3
2	Elect	rical characteristics	4
	2.1	Static	4
	2.2	Dynamic	4
3	Impe	dance data	5
4	Туріс	al performance	6
5	Test o	circuit	8
6	Circu	it layout	9
7	Packa	age mechanical data	0
8	Revis	sion history1	2

SD3931-10 Electrical data

1 Electrical data

1.1 Maximum ratings

Table 2. Absolute maximum ratings $(T_{CASE} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
V _{(BR)DSS} ⁽¹⁾	Drain source voltage	250	V
V_{DGR}	Drain-gate voltage ($R_{GS} = 1M\Omega$)	250	V
V _{GS}	Gate-source voltage	±20	V
I _D	Drain current	10	Α
P _{DISS}	Power dissipation	389	W
TJ	Max. operating junction temperature	200	°C
T _{STG}	Storage temperature	-65 to +150	°C

^{1.} $T_J = 150^{\circ}C$

1.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Junction - case thermal resistance	0.45	°C/W

Electrical characteristics SD3931-10

2 Electrical characteristics

 $T_{CASE} = +25$ °C

2.1 Static

Table 4. Static (per side)

Symbol		Min	Тур	Max	Unit		
V _{(BR)DSS} ⁽¹⁾	$V_{GS} = 0 V$	$I_{DS} = 100 \text{ mA}$		250			V
I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 100 V				1	mA
I _{GSS}	V _{GS} = 20 V	$V_{DS} = 0 V$				250	nA
V _{GS(Q)}	V _{DS} = 10 V	$I_D = 250 \text{ mA}$		1.5	2.5	4.0	٧
V _{DS(ON)}	V _{GS} = 10 V	$I_D = 5A$			2.5	3.5	V
G _{FS}	V _{DS} = 10 V	$I_D = 2.5 A$		2.5			S
C _{ISS}	$V_{GS} = 0 V$	V _{DS} = 100 V	f = 1 MHz		500		pF
C _{OSS}	$V_{GS} = 0 V$	V _{DS} = 100 V	f = 1 MHz		134		pF
C _{RSS}	$V_{GS} = 0 V$	V _{DS} = 100 V	f = 1 MHz		6		pF

^{1.} T_J = 150°C

2.2 Dynamic

Table 5. Dynamic

Symbol	Test conditions	Min	Тур	Max	Unit
P _{1dB}	$V_{DD} = 100 \text{ V}$ $I_{DQ} = 250 \text{ mA}$ $f = 150 \text{MHz}$	175	230		W
G _{PS}	$V_{DD} = 100 \text{ V } I_{DQ} = 250 \text{ mA } P_{OUT} = 175 \text{W } f = 150 \text{MHz}$	20	21.3		dB
n _D	$V_{DD} = 100 \text{ V}$ $I_{DQ} = 250 \text{ mA}$ $P_{OUT} = 175 \text{W f} = 150 \text{MHz}$	50	57		%
Load mismatch	V_{DD} = 100 V I_{DQ} = 250 mA P_{OUT} = 150W f = 150MHz All phase angles	3:1			VSWR

SD3931-10 Impedance data

3 Impedance data

Figure 2. Impedance data

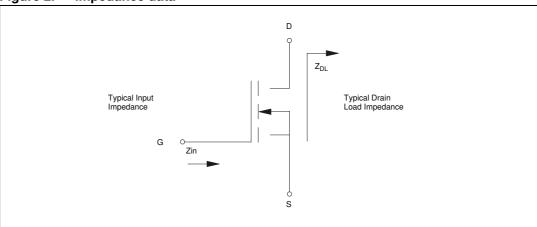


Table 6. Impedance data

Freq	Z _{IN} (Ω)	Z _{DL} (Ω)
150 MHz	0.42 - j 3.1	3.4 + j 5.5

Typical performance SD3931-10

4 Typical performance

Figure 3. Capacitances vs voltage

Figure 4. Gain vs output power and bias current

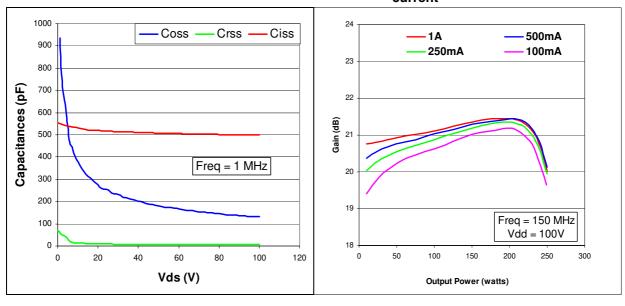
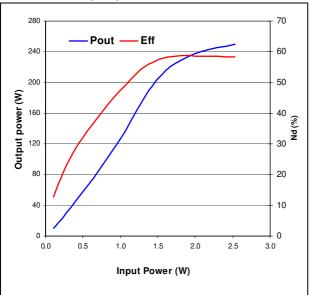


Figure 5. Output power and efficiency vs input power



SD3931-10 Typical performance

Figure 6. Zero temperature coefficient point

Table 7. Vgs sort (@250 mA)

Marking	Min	Max
DD	1.5	1.6
EE	1.6	1.7
FF	1.7	1.8
Α	1.8	1.9
В	1.9	2
С	2	2.1
D	2.1	2.2
E	2.2	2.3
F	2.3	2.4
G	2.4	2.5
Н	2.5	2.6
I	2.6	2.7
J	2.7	2.8
K	2.8	2.9
L	2.9	3
М	3	3.1
N	3.1	3.2
0	3.2	3.3
Р	3.3	3.4
Q	3.4	3.5
R	3.5	3.6
S	3.6	3.7
Т	3.7	3.8
U	3.8	3.9
V	3.9	4

Test circuit SD3931-10

5 Test circuit

Figure 7. Test circuit

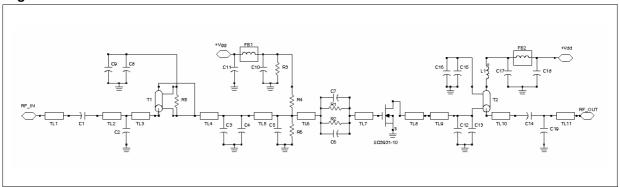


Table 8. Bill of materials

Component	Description
C1, C8	1200 pF ATC 700B chip capacitor
C2	1-20 Johanson air variable capacitor
C3, C4	120 pF ATC 100B chip capacitor
C5	300 pF ATC 100B chip capacitor
C6, C7	470 pF ATC 100B chip capacitor
C9, C10, C11	10,000 pF ATC 200B chip capacitor
C12, C16	470 pF ATC 100C chip capacitor
C13	120 pF ATC 100C chip capacitor
C14, C17	1,000 pF ATC 100C chip capacitor
C15	0.1 uF molded ceramic capacitor
C18	10 uF, 200 V electrolytic capacitor
C19	1-30 pF Johanson variable capacitor
R1, R2	5.1 Ω 1/4 W chip resistor
R3	470 Ω 1/8 W chip resistor
R4	430 Ω, 1/2 W chip resistor
R5	360 Ω 1/8 W chip resistor
R6	470 ohm, 1/2 W carbon axial lead resistor
FB1, FB2	ferrite bead, VK200
L1	RG-141, 13.6" thru Fair-Rite toroid #2643801502, 3 turns
TI	4:1 transformer, 25 Ω coaxial cable, 6", thru 2 x Fair-Rite toroid # 5943001101, 2 turn
T2	1:4 transformer, 25 ohm semi-rigid coaxial cable, OD .141", 6", 2 turns
TL1	0.340" x 0.175" microstrip

SD3931-10 Circuit layout

Table 8. Bill of materials (continued)

Component	Description
TL2	0.135" x 0.175" microstrip
TL3	0.225" x 0.175" microstrip
TL4	0.175" x 0.500" microstrip
TL5	0.805" x 0.500" microstrip
TL6	0.600" x 0.500" microstrip
TL7	0.420" x 0.500" microstrip
TL8	0.265" x 0.240" microstrip
TL9	1.550" x 0.180" microstrip
TL10	0.360" x 0.175" microstrip
TL11	0.300" x 0.175" microstrip
PCB	0.062" woven glass, copper clad, Er = 2.55

6 Circuit layout

Figure 8. Circuit layout photo



7 Package mechanical data

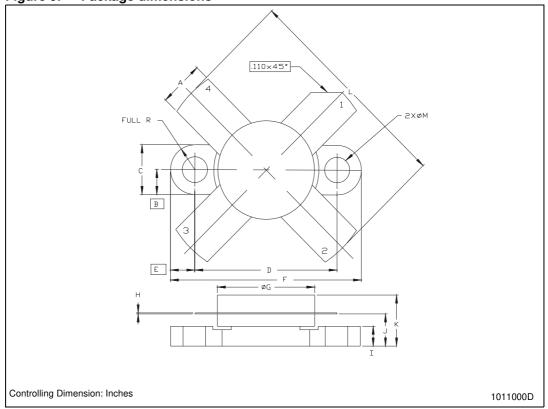
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10/13 Doc ID 13657 Rev 5

Table 9. M174 (0.500 DIA 4/L N/HERM W/FLG) mechanical data

Dim		mm.			Inch			
Dim.	Min	Тур	Max	Min	Тур	Max		
Α	5.56		5.584	0.219		0.230		
В		3.18			0.125			
С	6.22		6.48	0.245		0.255		
D	18.28		18.54	0.720		0.730		
E		3.18			0.125			
F	24.64		24.89	0.970		0.980		
G	12.57		12.83	0.495		0.505		
Н	0.08		0.18	0.003		0.007		
I	2.11		3.00	0.083		0.118		
J	3.81		4.45	0.150		0.175		
K			7.11			0.280		
L	25.53		26.67	1.005		1.050		
М	3.05		3.30	0.120		0.130		

Figure 9. Package dimensions



Revision history SD3931-10

8 Revision history

Table 10. Document revision history

Date	Revision	Changes
15-Jun-2007	1	First release
11-Jul-2007	2	Inserted Table 7: Vgs sort (@250 mA) on page 7
26-Oct-2007	3	Updated Table 4: Static (per side) on page 4 Added Section 5: Test circuit on page 8, Section 6: Circuit layout on page 9
11-Jul-2008	4	Updated Table 4: Static (per side) on page 4
07-Sep-2010	5	Updated features on cover page.

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